Product End-of-Life Disassembly Instructions

Product Category: Other Products
Marketing Name / Model [List multiple models if applicable.]
HP 3.6kVA 200-240V 16out WW mPDU/ D9N45A
HP 4.9kVA 208V 24out NA/JP mPDU/ D9N47A
HP 7.3kVA 230V 24out INTL mPDU/ D9N48A
HP 8.3kVA 208V 33out NA mPDU/ D9N49A
HP 7.3kVA 230V 36out INTL mPDU/ D9N50A
HP 8.6kVA 208V 3Ph 21out NA/JP mPDU/ D9N51A
HP 5.7kVA 208V 3Ph 21out NA/JP DV mPDU/ D9N52A
HP 8.6kVA 208V 3Ph 24out NA/JP DV mPDU/ D9N53A
HP 17.3kVA 208V 3Ph 27out NA/JP mPDU/ D9N54A
HP 11kVA 400V 3Ph 21out INTL mPDU/ D9N55A
HP 22kVA 400V 3Ph 33out INTL mPDU/ D9N56A
HP 11kVA 400V 3Ph 33out INTL mPDU/ D9N57A
HP 14.4kVA 208V 3Ph 24out NA/JP mPDU/ D9N58A
HP 17.3kVA 208V 3Ph 24out NA/JP mPDU/ D9N59A
HP 22kVA 400V 3Ph 24out INTL mPDU/ D9N60A
HP 16.6 kVA 400V 3Ph 33out NA/JP mPDU/ D9N61A
HP 16.6kVA 400V 3Ph 24out NA/JP mPDU/ D9N62A
HP 19.9kVA 480V 30out NA mPDU/ D9N63A

directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.
1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm Depending on model number	6
Batteries	All types including standard alkaline and lithium coin or button style batteries	0

Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		1
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Philips Screw Driver	#2
Torx Head Screw Driver	T10
Socket Wrench	M3

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Removal of bottom cover with T10 torx screw driver of unit.
2. Cut the internal wiring.
3. Removal of SCOB module with M3 socket wrench.
4. Removal of SPS+ICM PCBA with Philips screw Driver.
5. Removal of power cord with T10 torx screw Driver.
6. Removal of breaker with Philips Screw Driver.
7.
8.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

(1) The Component location of HP Glandore PDU 0U unit

(2) SCOB module disassembly

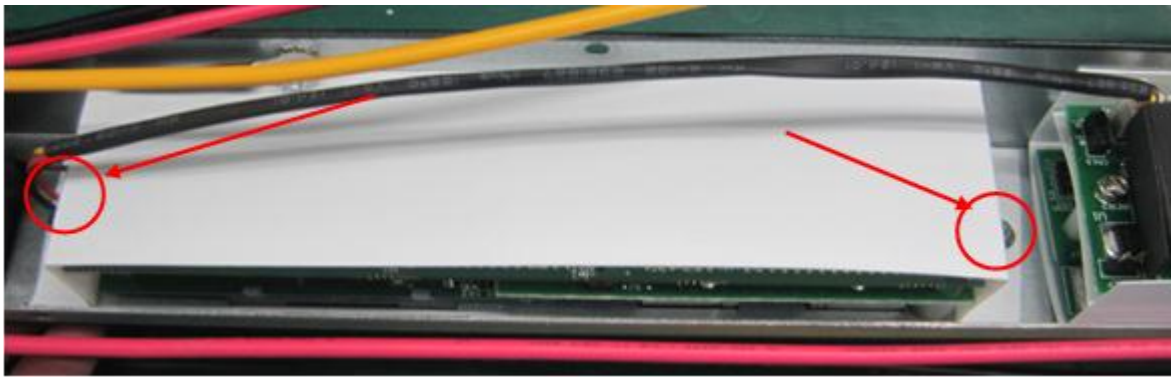
(3) PCBA disassembly

(4) Power Cord disassembly

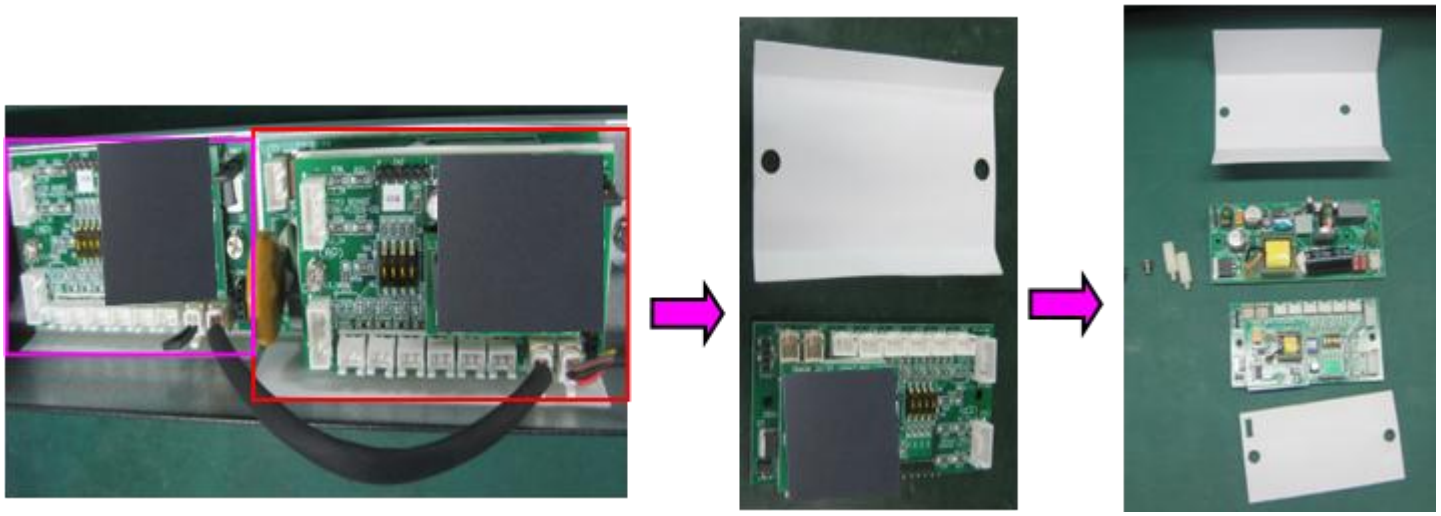
(5) Breaker disassembly

(1)The Component location of HP Glandore PDU 0U unit

(2)SCOB module disassembly



(3)PCBA disassembly



(4)Power Cord disassembly

(5)Breaker disassembly